

The listing of claims will replace all prior versions, and listings, of claims in the application:

**Listing of Claims:**

1.-13. (Canceled)

14. (New) A luminescent device comprising:  
a thin film transistor provided over an insulating surface;  
a luminescent element electrically connected with said thin film transistor,  
comprising:  
an organic compound layer containing an alkaline metal;  
an anode; and  
a cathode; and  
at least one insulating layer provided between said thin film transistor and said  
luminescent element,  
wherein said insulating layer is capable of adsorbing said alkaline metal.

15. (New) A device according to claim 14, wherein said at least one insulating  
layer comprises a silicon nitride film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more.

16. (New) A device according to claim 14, wherein said at least one insulating  
layer comprises an organic resin film containing a particle comprising an antimony (Sb)  
compound, a tin (Sn) compound, or indium (In) compound.

17. (New) A device according to claim 14, wherein said at least one insulating  
layer comprises a laminated layer of a silicon nitride film containing fluorine at a

concentration of  $1 \times 10^{19}/\text{cm}^3$  or more and an organic resin film containing a particle comprising an antimony (Sb) compound, a tin (Sn) compound, or indium (In) compound.

18. (New) A device according to claim 14, wherein said insulating layer comprises a silicon oxynitride film or a silicon oxide film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more.

19. (New) A luminescent device comprising:  
a thin film transistor provided over an insulating surface;  
a luminescent element electrically connected with said thin film transistor,  
comprising:

- an organic compound layer;
- an anode;
- a buffer layer containing an alkaline metal; and
- a cathode; and

at least one insulating layer provided between said thin film transistor and said luminescent element,

wherein said insulating layer is capable of adsorbing said alkaline metal.

20. (New) A device according to claim 19, wherein said at least one insulating layer comprises a silicon nitride film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more.

21. (New) A device according to claim 19, wherein said at least one insulating layer comprises an organic resin film containing a particle comprising an antimony (Sb) compound, a tin (Sn) compound, or indium (In) compound.

22. (New) A device according to claim 19, wherein said at least one insulating layer comprises a laminated layer of a silicon nitride film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more and an organic resin film containing a particle comprising an antimony (Sb) compound, a tin (Sn) compound, or indium (In) compound.

23. (New) A device according to claim 19, wherein said insulating layer comprises a silicon oxynitride film or a silicon oxide film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more.

24. (New) A luminescent device comprising:  
a thin film transistor provided over an insulating surface;  
a luminescent element electrically connected with said thin film transistor,  
comprising:  
an organic compound layer;  
an anode; and  
a cathode containing an alkaline-earth metal; and  
at least one insulating layer provided between said thin film transistor and said luminescent element,  
wherein said insulating layer is capable of adsorbing said alkaline-earth metal.

25. (New) A device according to claim 24, wherein said at least one insulating layer comprises a silicon nitride film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more.

26. (New) A device according to claim 24, wherein said at least one insulating layer comprises an organic resin film containing a particle comprising an antimony (Sb) compound, a tin (Sn) compound, or indium (In) compound.

27. (New) A device according to claim 24, wherein said at least one insulating layer comprises a laminated layer of a silicon nitride film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more and an organic resin film containing a particle comprising an antimony (Sb) compound, a tin (Sn) compound, or indium (In) compound.

28. (New) A device according to claim 24, wherein said insulating layer comprises a silicon oxynitride film or a silicon oxide film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more.

29. (New) A luminescent device comprising:  
a thin film transistor provided over an insulating surface;  
a luminescent element electrically connected with said thin film transistor,  
comprising:  
an organic compound layer containing an alkaline-earth metal;  
an anode; and  
a cathode; and  
at least one insulating layer provided between said thin film transistor and said luminescent element,  
wherein said insulating layer is capable of adsorbing said alkaline-earth metal.

30. (New) A device according to claim 29, wherein said at least one insulating layer comprises a silicon nitride film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more.

31. (New) A device according to claim 29, wherein said at least one insulating layer comprises an organic resin film containing a particle comprising an antimony (Sb) compound, a tin (Sn) compound, or indium (In) compound.

32. (New) A device according to claim 29, wherein said at least one insulating layer comprises a laminated layer of a silicon nitride film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more and an organic resin film containing a particle comprising an antimony (Sb) compound, a tin (Sn) compound, or indium (In) compound.

33. (New) A device according to claim 29, wherein said insulating layer comprises a silicon oxynitride film or a silicon oxide film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more.

34. (New) A luminescent device comprising:  
a thin film transistor provided over an insulating surface of a substrate;  
a luminescent element electrically connected with said thin film transistor,  
comprising:  
    an organic compound layer;  
    an anode;  
    a buffer layer containing an alkaline-earth metal; and  
    a cathode; and  
at least one insulating layer provided between said thin film transistor and said luminescent element  
wherein said insulating layer is capable of adsorbing said alkaline-earth metal.

35. (New) A device according to claim 34, wherein said at least one insulating layer comprises a silicon nitride film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more.

36. (New) A device according to claim 34, wherein said at least one insulating layer comprises an organic resin film containing a particle comprising an antimony (Sb) compound, a tin (Sn) compound, or indium (In) compound.

37. (New) A device according to claim 34, wherein said at least one insulating layer comprises a laminated layer of a silicon nitride film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more and an organic resin film containing a particle comprising an antimony (Sb) compound, a tin (Sn) compound, or indium (In) compound.

38. (New) A device according to claim 34, wherein said insulating layer comprises a silicon oxynitride film or a silicon oxide film containing fluorine at a concentration of  $1 \times 10^{19}/\text{cm}^3$  or more.